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	Filing Date		2004-04-22
	First Named Inventor	Bednasz	
	Art Unit	2617	
	Examiner Name	Cumming	
	Attorney Docket Number	2002-060	

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3	2004106801	JP	A	2004-04-08	Toshiba Corp		<input type="checkbox"/>
4	2001268490	JP	A	2001-09-28	Hewlett Packard Co <HP>		<input type="checkbox"/>
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